

OK TO ENTER: /J.M./

Docket No.: APPM/002592.C7/DSM/LOW K/JW
1016.013386
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
BEFORE THE BOARD OF PATENT APPEALS AND INTERFERENCES**

In re Application of:
Wai-Fan Yau, et al.

Serial No.: 10/756,122

Confirmation No.: 4554

Filed: January 13, 2004

For: A Low Dielectric Constant Film
Produced from Silicon
Compounds Comprising
Silicon-Carbon Bond

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Group Art Unit: 2823

Examiner: Julio J. Maldonado

REPLY BRIEF TO EXAMINER'S ANSWER DATED FEBRUARY 18, 2009

MS APPEAL BRIEF - PATENTS
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted via the Office electronic filing system in accordance with § 1.6(a)(4).

Dated: 4/2/09

Signature: 
(Keith M. Tackett)

Dear Sir:

Applicants submit this Reply Brief to the Board of Patent Appeals and Interferences on appeal from the decision of the Examiner of Group Art Unit 2823 dated July 22, 2008, finally rejecting claims 15-18, 21-25, 27, and 28. The final rejection of claims 15-18, 21-25, 27, and 28 is appealed. While Applicants maintain each of the arguments submitted in Applicants' previously submitted Appeal Brief, Applicants make the following further arguments in light of the Examiner's Answer.

This Reply Brief is believed to be timely since electronically transmitted by the due date of April 18, 2009, as set by mailing date of the Examiner's Answer mailed February 18, 2009. Please charge any additional fees that may be required to make this Reply Brief timely and acceptable to Deposit Account No. 20-0782/APPM/002592.C7/KMT.